Product data sheet

1. General description

Dual Silicon Carbide Schottky diode in a 3-lead TO-247 plastic package, designed for high frequency switched-mode power supplies.

2. Features and benefits

- · Highly stable switching performance
- High forward surge capability IFSM
- · Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- · Reduced cooling requirements
- RoHS compliant

3. Applications

- Power factor correction
- Telecom / Server SMPS
- UPS
- PV inverter
- Electrical Vehicle Charger
- Motor Drives

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	-	650	V
I _{O(AV)}	limiting average output current	$T_{mb} \le 74$ °C; $\delta_{factor} = 0.5$; squarewave pulse; both diodes conducting; Fig. 1; Fig. 2; Fig. 3; Fig. 4	-	-	20	A
Tj	junction temperature		-	-	175	°C
Static characte	eristics					
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.65	1.85	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>	-	2.1	2.5	V
Dynamic chara	acteristics					,
Q _r	recovered charge	$I_F = 10 \text{ A; } dI_F/dt = 500 \text{ A/}\mu\text{s;}$ $V_R = 400 \text{ V; } T_j = 25 \text{ °C; } Fig. 7$	-	11	-	nC

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode		A1
2	K	cathode		
3	A2	anode		K sym125
mb	mb	mounting base; connected to cathode	1 2 3 TO-247 (SOT429N)	

6. Ordering information

Table 3. Ordering information

Type number	Package					
	Name	Description	Version			
NXPLQSC20650W	TO-247	Plastic single-ended through-hole package; heatsink mounted; 1 mounting hole; 3-lead TO-247	SOT429N			

7. Marking

Table 4. Marking codes

Type number	Marking code
NXPLQSC20650W	NXPLQSC20650W

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8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage		-	650	V
V_{RWM}	crest working reverse voltage		-	650	V
V_R	reverse voltage	DC	-	650	V
I _{FRM}	repetitive peak forward current	δ = 0.5 ; t_p = 25 μ s; $T_{mb} \le 88$ °C; squarewave pulse; per diode	-	20	Α
I _{O(AV)}	limiting average output current	$T_{mb} \le 74$ °C; $\delta_{factor} = 0.5$; square-wave pulse; both diodes conducting; <u>Fig. 1</u> ; <u>Fig. 2</u> ; <u>Fig. 3</u> ; <u>Fig. 4</u>	-	20	A
I _{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse; per diode	-	52	A
		t_p = 10 μ s; $T_{j(init)}$ = 25 °C; square-wave pulse; per diode	-	385	Α
T _{stg}	storage temperature		-55	175	°C
T _j	junction temperature		-	175	°C

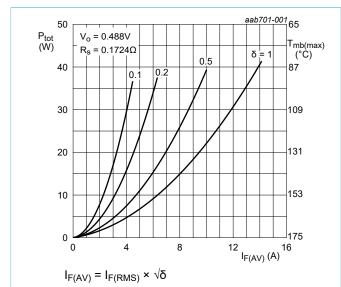


Fig. 1. Forward power dissipation as a function of average forward current; square waveform; per diode

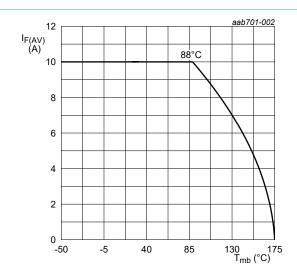


Fig. 2. Forward current as a function of mounting base temperature; per diode

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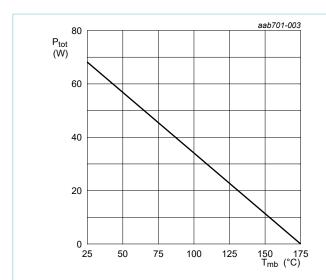


Fig. 3. Total power dissipation as a function of mounting base temperature; per diode

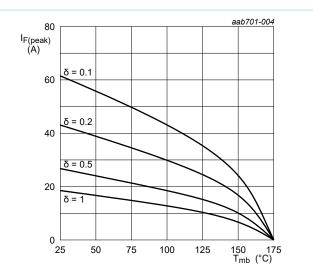
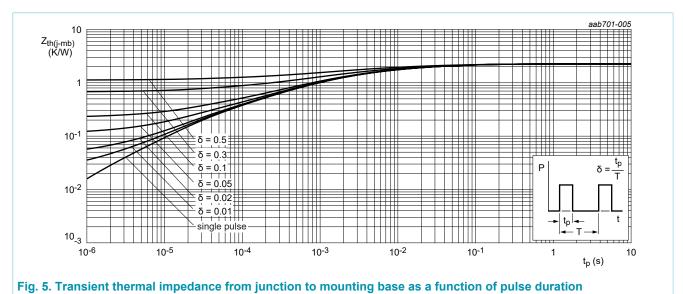


Fig. 4. Current derating as a function of mounting base temperature; per diode

9. Thermal characteristics

Table 6. Thermal characteristics

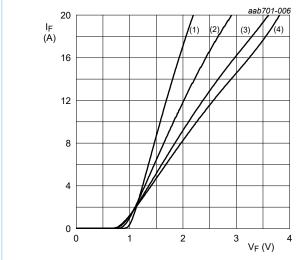
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance	per diode; Fig. 5	-	-	2.2	K/W
	from junction to mounting base	both diodes conducting	-	-	1.3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	45	-	K/W



10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	cteristics					
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; <u>Fig. 6</u>	-	1.65	1.85	V
		I _F = 10 A; T _j = 150 °C; <u>Fig. 6</u>	-	2.1	2.5	V
I _R	reverse current	V _R = 650 V; T _j = 25 °C	-	-	230	μΑ
		V _R = 650 V; T _j = 150 °C	-	-	700	μΑ
Dynamic ch	aracteristics					,
Q _r	recovered charge	$I_F = 10 \text{ A}; dI_F/dt = 500 \text{ A}/\mu\text{s};$ $V_R = 400 \text{ V}; T_j = 25 ^{\circ}\text{C}; Fig. 7$	-	11	-	nC
C _d	diode capacitance	f = 1 MHz; V _R = 1 V; T _j = 25 °C	-	250	-	pF
		$f = 1 \text{ MHz}; V_R = 300 \text{ V}; T_j = 25 ^{\circ}\text{C}$	-	26	-	pF
		f = 1 MHz; V _R = 600 V; T _j = 25 °C	-	21	-	pF



(1) T_j = 25 °C; typical values (2) T_j = 100 °C; typical values (3) T_j = 150 °C; typical values (4) T_j = 175 °C; typical values

Fig. 6. Forward current as a function of forward voltage; typical values; per diode

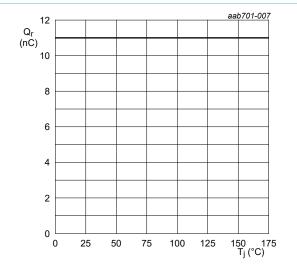


Fig. 7. Recovered charge as a function of junction temperature; per diode

11. Package outline

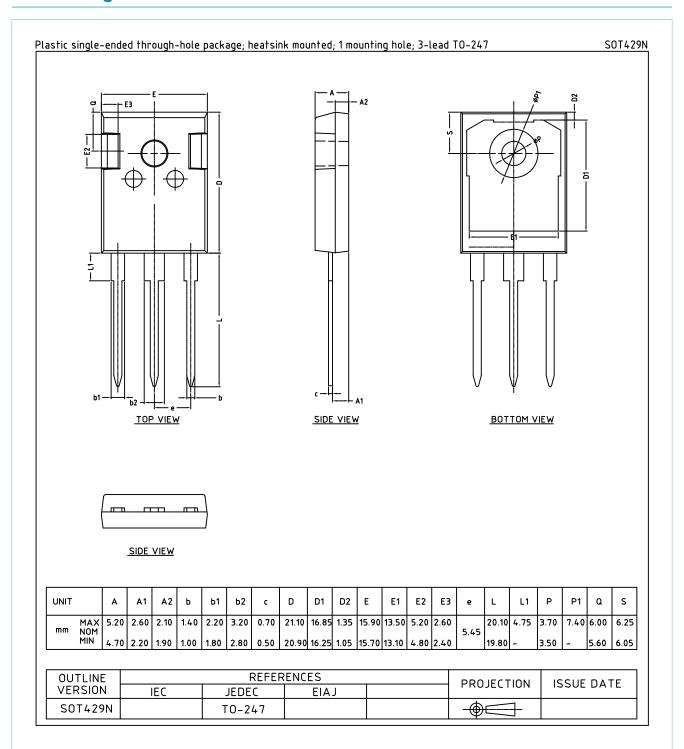


Fig. 8. Package outline TO-247 (SOT429N)

12. Legal information

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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For more information, please visit: http://www.ween-semi.com For sales office addresses, please send an email to: salesaddresses@ween-semi.com Date of release: 22 November 2016

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Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: <u>org@eplast1.ru</u>

Адрес: 198099, г. Санкт-Петербург, ул. Калинина,

дом 2, корпус 4, литера А.